TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VCX16646FT

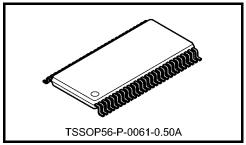
Low-Voltage 16-Bit Bus Transceiver/Register with 3.6-V Tolerant Inputs and Outputs

The TC74VCX16646FT is a high-performance CMOS 16-bit bus transceiver/register. Designed for use in 1.8-V, 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is also designed with overvoltage tolerant inputs and outputs up to 3.6 V.

This device is bus transceiver with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the internal registers.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.25 g (typ.)

Features (Note)

- Low-voltage operation: $V_{CC} = 1.8$ to 3.6 V
- High-speed operation: $t_{pd} = 2.9 \text{ ns} (max) (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$

$$t_{pd}$$
 = 3.5 ns (max) (V_{CC} = 2.3 to 2.7 V)

$$t_{pd} = 7.0 \text{ ns} (max) (V_{CC} = 1.8 \text{ V})$$

• Output current: $I_{OH}/I_{OL} = \pm 24 \text{ mA} \text{ (min)} (V_{CC} = 3.0 \text{ V})$

$$: I_{OH}/I_{OL} = \pm 18 \text{ mA (min)} (V_{CC} = 2.3 \text{ V})$$

$$: I_{OH}/I_{OL} = \pm 6 \text{ mA} \text{ (min)} (V_{CC} = 1.8 \text{ V})$$

- Latch-up performance: -300 mA
- ESD performance: Machine model $\geq \pm 200$ V

Human body model ≥ ±2000 V

- Package: TSSOP
- Bidirectional interface between 2.5 V and 3.3 V signals.
- 3.6-V tolerant function and power-down protection provided on all inputs and outputs

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

All floating (high impedance) bus pins must have their input level fixed by means of pull-up or pull-down resistors.

Pin Assignment (top view)

	1			
1DIR	1	0	56	10E
1CAB	2		55	1CBA
1SAB	3		54	1SBA
GND	4		53	GND
1A1	5		52	1B1
1A2	6		51	1B2
V _{CC}	7		50	V _{CC}
1A3	8		49	1B3
1A4	9		48	1B4
1A5	10		47	1B5
GND	11		46	GND
1A6	12		45	1B6
1A7	13		44	1B7
1A8	14		43	1B8
2A1	15		42	2B1
2A2	16		41	2B2
2A3	17		40	2B3
GND	18		39	GND
2A4	19		38	2B4
2A5	20		37	2B5
2A6	21		36	2B6
V _{CC}	22		35	V _{CC}
2A7	23		34	2B7
2A8	24		33	2B8
GND	25		32	GND
2SAB	26		31	2SBA
2CAB	27		30	2CBA
2DIR	28		29	20E
			I.	

IEC Logic Symbol

10E - 1DIR -			G3 3EN1 (B	A)				
			3EN2 (A					
1CBA-	55		>C4	,				
1SBA -	54		G5					
1CAB -	2		>C6					
1SAB -	3		G7					
20E -	29		G10					
2DIR -	28	\	10EN8 (I	BA)				
			10EN9 (/					
2CBA -	30		>C11					
2SBA -	31		G12					
2CAB -	27		⊃C13					
2SAB -	26		G14					
20/10								
	F		≥ 1	5	4D		52	- 1B1
1A1 -	5	→ ←	√1		1			101
			6D 7	-	' 1			
				Í	' 2 ▽			
					2 V			
1A2 -	6	\leftrightarrow				\longrightarrow	51	- 1B2
1A3 -	8	\leftrightarrow	-			\longrightarrow	49	- 1B3
1A4 -	9	\leftrightarrow				\longrightarrow	48	- 1B4
1A5 -	10	\leftrightarrow				\longrightarrow	47	- 1B5
1A6 -	12	\leftrightarrow				\longrightarrow	45	- 1B6
1A7 -	13	\leftrightarrow				\longrightarrow	44	- 1B7
1A8 -	14	\leftrightarrow				\longrightarrow	43	- 1B8
				40	110			- 2B1
2A1 -	15		≥ 1	12	11D			- 2B I
			∀ 8		1			
			13D 14	≥	1 ∧ \			
		L	14 1		9 🗸			
2A2 -	16	$ \rightarrow $	-			\rightarrow	41	- 2B2
_,								
2A3 -	17	\leftrightarrow	-			\rightarrow	40	- 2B3
2/10								200
244 -	19	\leftrightarrow				\longrightarrow	38	- 2R4
274								204
245	20	\leftrightarrow					37	285
243-		` /				``		200
246	21	\leftrightarrow					36	286
2A0 -		``				``		200
2 ∧7	23	\leftrightarrow				`	34	- 287
281 -		,				\rightarrow		- ZD /
210	<u>2</u> 4	\leftrightarrow				\rightarrow	<u>3</u> 3	200
240-		\rightarrow				\rightarrow		200

Truth Table

		Contro	l Inputs			В	us	Function		
ŌĒ	DIR	CAB	CBA	SAB	SBA	А	В	Function		
		X*	X*	х	х	Input	Input	The output functions of A and B Busses are		
н	x	~	^	~	~	Z	Z	disabled.		
	^	Ĺ		х	х	х	х	Both A and B Busses are used as inputs to the internal flip-flops. Data on the Bus will be stored on the rising edge of the Clock.		
						Input	Output			
		X*	X*	L	х	L	L	The data on the A bus are displayed on the B bus.		
						Н	Н			
			X*	L	x	L	L	The data on the A bus are displayed on the		
L	н		^ *	L	^	н	Н	B Bus, and are stored into the A storage flip-flops on the rising edge of CAB.		
		X*	X*	Н	х	х	Qn	The data in the A storage flop-flops are displayed on the B Bus.		
							L	L	The data on the A Bus are stored into the A	
			Х*	Н	Х	Н	Н	storage flip-flops on the rising edge of CAB, and the stored data propagate directly onto the B Bus.		
						Output	Input			
		X*	X*	х	L	L	L	The data on the B Bus are displayed on the A bus.		
						Н	Н			
		X*		х	L	L	L	The data on the B Bus are displayed on the		
L	L	~.		^	L	н	Н	A Bus, and are stored into the B storage flip-flops on the rising edge of CBA.		
		X*	X*	х	Н	Qn	х	The data in the B storage flip-flops are displayed on the A Bus.		
					<u> </u>			L	L	The data on the B Bus are stored into the B
		Х*		Х	Н	Н	Н	storage flip-flops on the rising edge of CBA, and the stored data propagate directly onto the A Bus.		

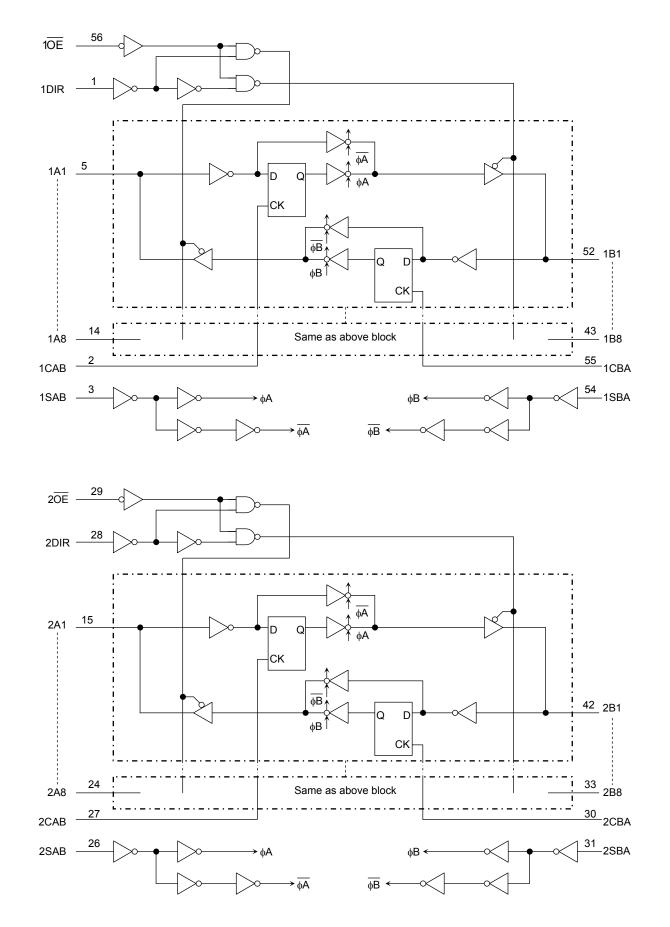
X: Don't care

Z: High impedance

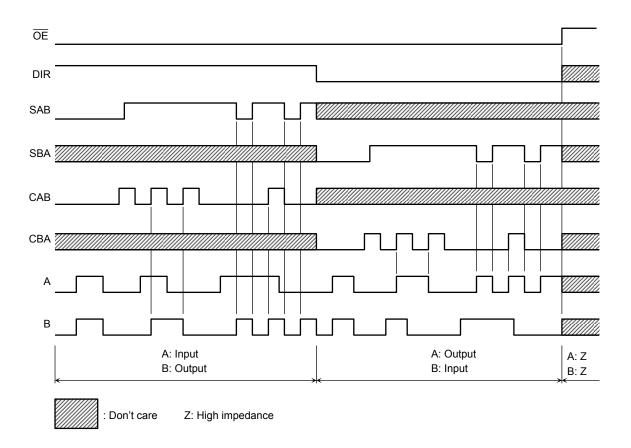
Qn: The data stored into the internal flip-flops by most recent low to high transition of the clock inputs.

*: The clocks are not internally with either \overline{OE} or DIR. Therefore, data on the A and/or B busses may be clocked into the storage flip-flops at any time.

System Diagram



Timing Chart



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol Rating		Unit	
Power supply voltage	V _{CC}	-0.5 to 4.6	V	
DC input voltage (DIR, OE, CAB, CBA, SAB, SBA)	V _{IN}	-0.5 to 4.6	V	
		-0.5 to 4.6 (Note 2)		
DC bus I/O voltage	V _{I/O}	–0.5 to V _{CC} + 0.5	V	
		(Note 3)		
Input diode current	I _{IK}	-50	mA	
Output diode current	IOK	±50 (Note 4)	mA	
DC output current	IOUT	±50	mA	
Power dissipation	PD	400	mW	
DC V_{CC}/ground current per supply pin	I _{CC} /I _{GND}	±100	mA	
Storage temperature	T _{stg}	–65 to 150	°C	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 2: OFF state
- Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: $V_{OUT} < GND, V_{OUT} > V_{CC}$

Operating Ranges (Note 1)

Characteristics	Symbol Rating		Unit		
Power supply voltage	V _{CC}	1.8 to 3.6	V		
Fower supply voltage	VCC	1.2 to 3.6 (Note 2)	v		
Input voltage (DIR, OE, CAB, CBA, SAB, SBA)	V _{IN}	-0.3 to 3.6	V		
Bus I/O voltage	VI/O	0 to 3.6 (Note 3)	V		
Bus i/O voltage	VI/O	0 to V _{CC} (Note 4)	v		
		±24 (Note 5)			
Output current	I _{OH} /I _{OL}	±18 (Note 6)	mA		
		±6 (Note 7)			
Operating temperature	T _{opr}	-40 to 85	°C		
Input rise and fall time	dt/dv	0 to 10 (Note 8)	ns/V		

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

- Note 3: OFF state
- Note 4: High or low state
- Note 5: $V_{CC}=3.0 \mbox{ to } 3.6 \mbox{ V}$
- Note 6: $V_{CC} = 2.3$ to 2.7 V
- Note 7: $V_{CC} = 1.8 V$
- Note 8: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V

Electrical Characteristics

DC Characteristics (Ta = –40 to 85°C, 2.7 V < V_{CC} \leq 3.6 V)

Characte	rictice	Symbol	Tost	Condition		Min	Max	Unit
				V _{CC} (V)	IVIIII	WIGA	Offic	
Input voltage	H-level	VIH		_	2.7 to 3.6	2.0		V
input voltage	L-level	VIL		_	2.7 to 3.6		0.8	v
H-level Output voltage			I _{OH} = -100 μA	2.7 to 3.6	V _{CC} - 0.2	_		
	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -12 mA	2.7	2.2	_		
			I _{OH} = -18 mA	3.0	2.4	_		
			I _{OH} = -24 mA	3.0	2.2	_	V	
			I _{OL} = 100 μA	2.7 to 3.6	_	0.2		
	L-level	V _{OL}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OL} = 12 mA	2.7	_	0.4	
	L-level			I _{OL} = 18 mA	3.0	_	0.4	
				I _{OL} = 24 mA	3.0	_	0.55	
Input leakage curr	ent	I _{IN}	$V_{IN} = 0$ to 3.6 V		2.7 to 3.6	_	±5.0	μA
3-state output OFF state current I_{OZ} $V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 3.6 \text{ V}$			2.7 to 3.6	_	±10.0	μA		
Power-off leakage	current	IOFF	V _{IN} , V _{OUT} = 0 to 3.6 V		0		10.0	μA
			$V_{IN} = V_{CC}$ or GND		2.7 to 3.6	_	20.0	
Quiescent supply	current	ICC	$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 \text{ V}$		2.7 to 3.6	_	±20.0	μA
Increase in I _{CC} pe	r input	Δlcc	$V_{IH} = V_{CC} - 0.6 \ V$		2.7 to 3.6		750	

DC Characteristics (Ta = -40 to 85°C, 2.3 V \leq V_{CC} \leq 2.7 V)

Character	Characteristics Symbol Test Condition		V _{CC} (V)	Min	Max	Unit			
Input voltage	H-level	VIH	-	_	2.3 to 2.7	1.6	_	V	
Input voltage	L-level	VIL	-		2.3 to 2.7	_	0.7	v	
				I _{OH} = -100 μA	2.3 to 2.7	V _{CC} - 0.2	_		
	H-level	V _{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OH} = -6 mA	2.3	2.0	_		
Output voltage				I _{OH} = -12 mA	2.3	1.8	_	V	
				I _{OH} = -18 mA	2.3	1.7	_		
		V _{OL}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OL} = 100 μA	2.3 to 2.7	_	0.2		
	L-level			I _{OL} = 12 mA	2.3	_	0.4		
				I _{OL} = 18 mA	2.3	_	0.6		
Input leakage curre	ent	I _{IN}	V _{IN} = 0 to 3.6 V		2.3 to 2.7	_	±5.0	μA	
	atata ourrant	1	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$V_{IN} = V_{IH} \text{ or } V_{IL}$			±10.0	A	
3-state output OFF state current		loz	V _{OUT} = 0 to 3.6 V		2.3 to 2.7		±10.0	μA	
Power-off leakage	current	IOFF	V_{IN} , $V_{OUT} = 0$ to 3.6 V		0	_	10.0	μA	
Quiescent supply of			$V_{IN} = V_{CC}$ or GND		2.3 to 2.7	—	20.0		
Quiescent supply t	unent	Icc	$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.0$	6 V	2.3 to 2.7	_	±20.0	μA	

DC Characteristics (Ta = -40 to 85°C, 1.8 V \leq V_{CC} < 2.3 V)

Characteris	stics	Symbol	Test Co	Test Condition		Min	Max	Unit	
Input voltage	H-level	VIH	_	_	1.8 to 2.3	$0.7 \times V_{CC}$	_	V	
mput voltage	L-level	VIL	_	_	1.8 to 2.3	_	$0.2 \times V_{CC}$	v	
	H-level	V _{OH}	VIN = VIH or VII	I _{OH} = -100 μA	1.8	V _{CC} - 0.2	_		
Output voltage	Output voltage	011		I _{OH} = -6 mA	1.8	1.4		v	
	L-level	Vai		I _{OL} = 100 μA	1.8	_	0.2		
	L-level	V _{OL}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OL} = 6 mA	1.8		0.3		
Input leakage currer	nt	I _{IN}	V _{IN} = 0 to 3.6 V		1.8		±5.0	μA	
3-state output OFF	state current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 3.6 \text{ V}$		1.8		±10.0	μA	
Power-off leakage c	urrent	I _{OFF}	V_{IN} , $V_{OUT} = 0$ to 3.6 V		0	_	10.0	μA	
Quiescent supply cu	urrent		$V_{IN} = V_{CC}$ or GND		1.8		20.0		
Quescent supply cu		Icc	$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 \text{ V}$		1.8		±20.0	μA	

AC Characteristics (Ta = -40 to 85°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF, $R_L = 500$ Ω) (Note 1)

Characteristics	Symbol	Test Condition		Min	Max	Unit
Characteristics	Symbol	Test Condition	$V_{CC}(V)$	IVIIII	Wax	Unit
			1.8	100	_	MHz
Maximum clock frequency	f _{max}	Figure 1, Figure 3	2.5 ± 0.2	200	_	
			$\textbf{3.3}\pm\textbf{0.3}$	250		
Descention delay firm			1.8	1.5	7.0	
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2	0.8	3.5	ns
(An, Bn-Bn, An)	t _{pHL}		$\textbf{3.3}\pm\textbf{0.3}$	0.6	2.9	
Dranamation delay time			1.8	1.5	8.8	
	pagation delay time t _{pLH}	Figure 1, Figure 3	2.5 ± 0.2	0.8	4.4	ns
(CAB, CBA-Bn, An)	t _{pHL}		$\textbf{3.3}\pm\textbf{0.3}$	0.6	3.2	
Dranamatian dalay time			1.8	1.5	8.8	
Propagation delay time (SAB, SBA-Bn, An)	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2	0.8	4.4	ns
	t _{pHL}		$\textbf{3.3}\pm\textbf{0.3}$	0.6	3.5	
			1.8	1.5	9.8	
Output enable time (OE , DIR-An, Bn)	t _{pZL}	Figure 1, Figure 4, Figure 5	2.5 ± 0.2	0.8	4.9	ns
(UE , DIR-AII, BII)	^t pZH		$\textbf{3.3}\pm\textbf{0.3}$	0.6	3.8	
Output dischla time		Figure 1, Figure 4, Figure 5	1.8	1.5	7.6	ns
Output disable time (OE , DIR-An, Bn)	t _{pLZ}		2.5 ± 0.2	0.8	4.2	
(UE, DIR-AII, BII)	^t pHZ		$\textbf{3.3}\pm\textbf{0.3}$	0.6	3.7	
			1.8	4.0	_	
Minimum pulse width	^t w (H)	Figure 1, Figure 3	2.5 ± 0.2	1.5	_	ns
	t _{w (L)}		$\textbf{3.3}\pm\textbf{0.3}$	1.5	_	
			1.8	2.5	_	
Minimum setup time	ts	Figure 1, Figure 3	2.5 ± 0.2	1.5	_	ns
			$\textbf{3.3}\pm\textbf{0.3}$	1.5	_	
Minimum hold time			1.8	1.0		
	t _h	Figure 1, Figure 3	2.5 ± 0.2	1.0		ns
			$\textbf{3.3}\pm\textbf{0.3}$	1.0		
	+		1.8	_	0.5	
Output to output skew	t _{osLH}	(Note 2)	2.5 ± 0.2	_	0.5	ns
	t _{osHL}		$\textbf{3.3}\pm\textbf{0.3}$	_	0.5	

Note 1: For $C_L = 50 \text{ pF}$, add approximately 300 ps to the AC maximum specification.

Note 2: Parameter guaranteed by design. $(t_{osLH} = |t_{pLHm} - t_{pLHn}|, \ t_{osHL} = |t_{pHLm} - t_{pHLn}|)$

Dynamic Switching Characteristics

(Ta = 25°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF, $R_L = 500 \Omega$)

Characteristics	Symbol	Test Condition			Тур.	Unit	
				$V_{CC}(V)$			
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	1.8	0.25		
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	2.5	0.6	V	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	3.3	0.8		
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	1.8	-0.25		
Quiet output minimum dynamic V _{OI}	V _{OLV}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	2.5	-0.6	V	
,		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	3.3	-0.8		
Quiet output minimum V dynamic V _{OH}		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$	(Note)	1.8	1.5		
	VOHV	$V_{IH} = 2.5 V, V_{IL} = 0 V$	(Note)	2.5	1.9	V	
		$V_{IH} = 3.3 V, V_{IL} = 0 V$	(Note)	3.3	2.2		

Note: Parameter guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

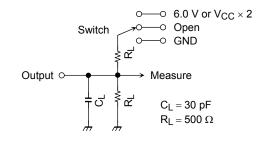
Characteristics	Symbol	Test Condition	[V _{CC} (V)	Тур.	Unit
Input capacitance	CIN	(DIR, OE, CAB, CBA, SAB, SBA)		1.8, 2.5, 3.3	6	pF
Bus I/O capacitance	C _{I/O}			1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (N	Note)	1.8, 2.5, 3.3	20	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$

AC Test Circuit



Parameter	Switch				
t _{pLH} , t _{pHL}	Open				
t _{pLZ} , t _{pZL}					
t _{pHZ} , t _{pZH}	GND				



AC Waveform

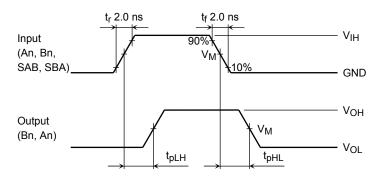


Figure 2 t_{pLH}, t_{pHL}

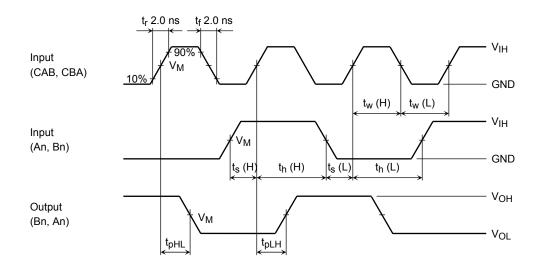
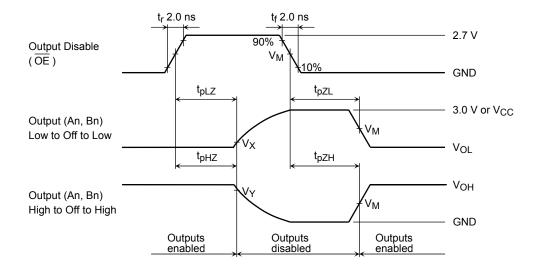
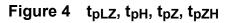
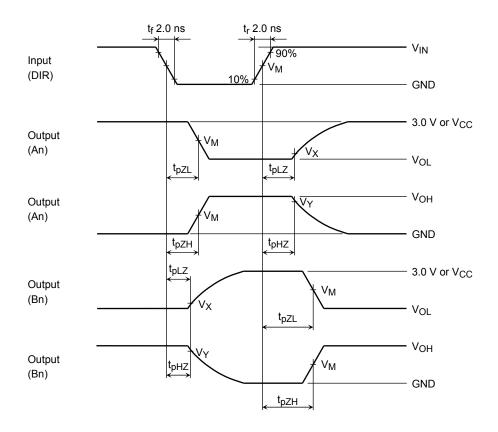
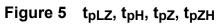


Figure 3 $t_{pLH}, t_{pHL}, t_w, t_s, t_h$



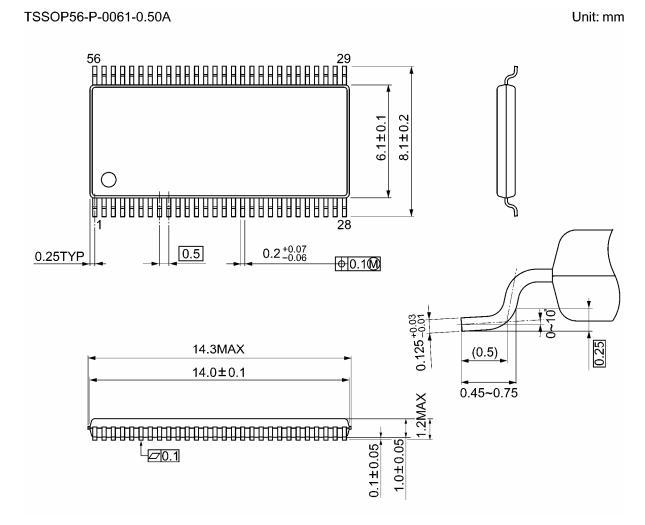






Symbol	V _{CC}		
	$3.3\pm0.3~\text{V}$	$2.5\pm0.2~V$	1.8 V
VIH	2.7 V	V _{CC}	V _{CC}
VM	1.5 V	V _{CC} /2	V _{CC} /2
VX	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V
VY	V _{OH} – 0.3 V	V _{OH} – 0.15 V	V _{OH} – 0.15 V

Package Dimensions



Weight: 0.25 g (typ.)

RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

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